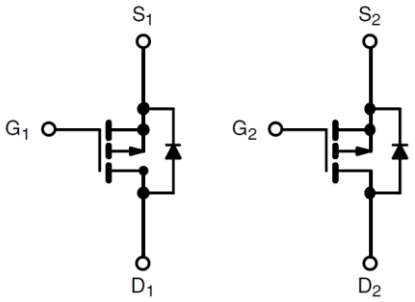
MSH40P07D

Dual P-Channel 40-V (D-S) MOSFET

Description

The device is using trench DMOS technology. This advanced technology has been especially tailored to minimize $R_{DS(ON)}$, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

Graphic Symbol



Features

- $R_{DS(ON)}$ = 45mΩ @ V_{GS} =10V
- Fast switching
- Improve dv/dt Capability
- 100% EAS Guaranteed
- Green Device Available

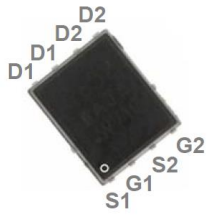
Typical Applications

- Motor Drive
- LED Lighting
- Hand-held Device

Package type：PDFN 5X6 Dual

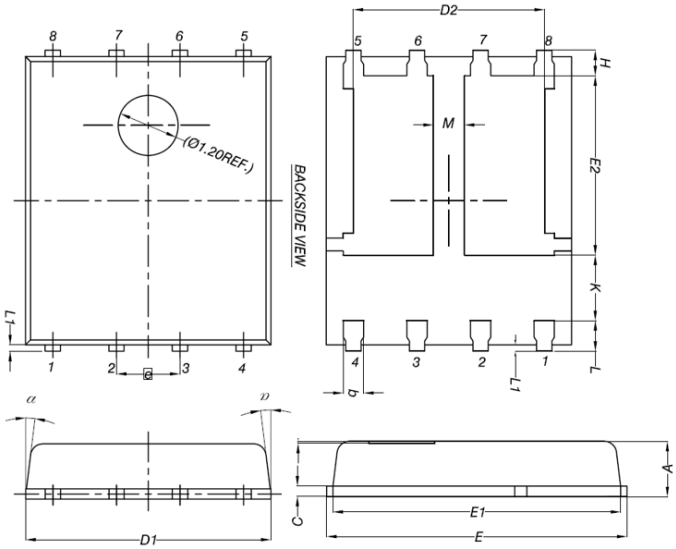
Packing & Order Information

3,000/Reel



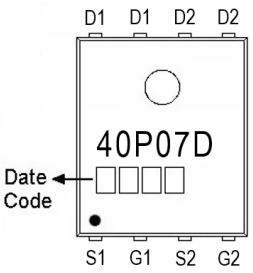
RoHS Compliant

Package Dimension



REF.	Millimeter			REF.	Millimeter		
	Min.	Nom.	Max.		Min.	Nom.	Max.
A	0.90	1.10	1.10	E2	3.38	3.58	3.78
b	0.33	0.41	0.51	H	0.41	0.51	0.61
C	0.20	0.25	0.30	K	1.10	-	6.20
D1	4.80	4.90	5.00	L	0.51	0.61	0.71
D2	3.61	3.81	3.96	L1	0.06	0.13	0.20
E	5.90	6.00	6.10	M	0.50	-	-
E1	5.70	5.75	5.80	a	0℃	-	12℃
e	1.27 BSC						

Marking



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MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)			
Symbol	**Parameter**	**Value**	**Unit**
V_{DS}	Drain-Source Voltage	-40	V
V_{GS}	Gate-Source Voltage	±20	V
I_D	Continuous Drain Current @ T_C=25°C	-18.8	A
	Continuous Drain Current @ T_C=70°C	-14	A
I_{DM}	Pulsed Drain Current[2]	-50	A
I_{AS}	Single Pulse Avalanche Current, L =0.1mH[3]	-24	A
E_{AS}	Single Pulse Avalanche Energy, L =0.1mH[3]	28.8	mJ
P_D	Power Dissipation (T_C=25°C)	25	W
T_j, T_{stg}	Operating Junction and Storage Temperature	-55~+150	°C

Thermal Resistance Ratings			
Symbol	**Parameter**	**Value**	**Unit**
$R_{\theta JA}$	Maximum Junction-to-Ambient[1]	85	°C/W
$R_{\theta JC}$	Maximum Junction-to-Case	5	°C/W

Electrical Characteristics (T_J=25°C unless otherwise specified)						
Symbol	**Parameter**	**Test Conditions**	**Min.**	**Typ.**	**Max.**	**Units**
$V_{GS\ (th)}$	Gate Threshold Voltage	V_{DS} =V_{GS}, I_D =-250μA	-1	-	-2.5	V
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V, I_D =-250μA	-40	-	-	V
I_{GSS}	Gate-Source Leakage Current	V_{DS} =0V, V_{GS} =±20V	-	-	±100	nA
I_{DSS}	Drain-Source Leakage Current	V_{DS} =-32V, V_{GS} =0V, T_J =25°C	-	-	-1	μA
		V_{DS} =-32V, V_{GS} =0V, T_J =55°C			-5	
$R_{DS\ (on)}$	Static Drain-Source On-Resistance[2]	V_{GS} =-10V, I_D =-6A	-	38	45	mΩ
		V_{GS} =-4.5V, I_D =-4A	-	61	75	
EAS	Single Pulse Avalanche Energy[5]	V_{DD} =25V, L =0.1mH, I_{AS} =-12A	7.2	-	-	mJ
V_{SD}	Diode Forward Voltage[2]	I_S =1A, V_{GS} =0V, T_J =25°C	-	-	-1.2	V
I_S	Continuous Source Current[1,6]	V_G =V_D =0V, Force Current	-	-	-7	A
I_{SM}	Pulsed Source Current[2,6]		-	-	-14	

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Dynamic						
Symbol	**Parameter**	**Test Conditions**	**Min.**	**Typ.**	**Max.**	**Units**
Q_g	Total Gate Charge[2]	V_{DS} =-20V	--	9	--	nC
Q_{gs}	Gate-Source Charge	I_D =-6A	--	2.5	--	
Q_{gd}	Gate-Drain Charge	V_{GS} =-4.5V	--	3.1	--	
$t_{d(on)}$	Turn-On Delay Time[2]	V_{DS} =-15V	--	19.2	--	ns
t_r	Rise Time	I_D =-1A	--	12.8	--	
$t_{d(off)}$	Turn-Off Delay Time	V_{GS} =-10V	--	48.6	--	
t_f	Fall Time	R_G =3.3Ω	--	4.6	--	
C_{ISS}	Input Capacitance	V_{DS} =-15V	--	1004	--	pF
C_{OSS}	Output Capacitance	V_{GS} =0V	--	108	--	
C_{RSS}	Reverse Transfer Capacitance	f =1.0MHz	--	80	--	
Rg	Gate Resistance	V_{DS} =0V, V_{GS} =0V, f =1.0MHz		16		Ω

Notes

1. The data tested by surface mounted on a 1 inch^2 FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
3. The EAS data shows maximum rating. The test condition is V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=-24A.
4. The power dissipation is limited by 150℃ junction temperature.
5. The Min. value is 100% EAS tested guarantee.
6. The data is theoretically the same as I_D and I_{DM}, in real applications, should be limited by total power dissipation.

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- **Typical Electrical Characteristics**

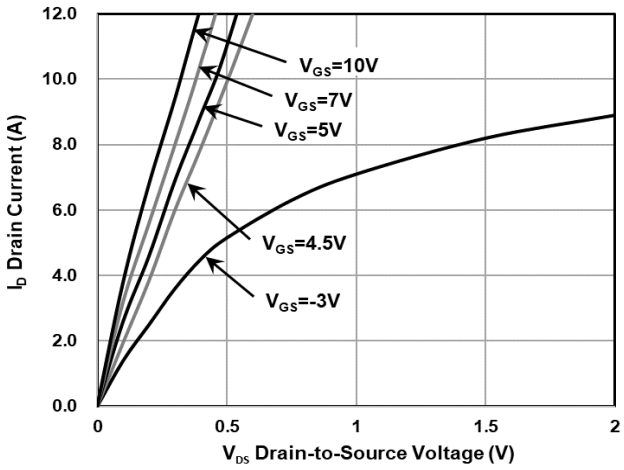

FIG.1-Typical Output Characteristics

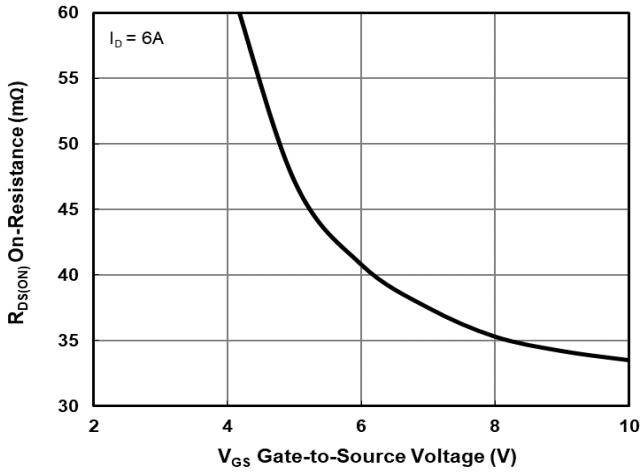

FIG.2-On-Resistance vs. G-S Voltage

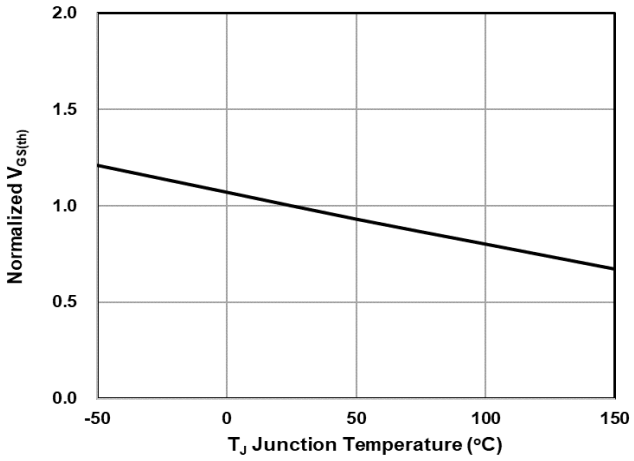

FIG.3-Normalized $V_{GS(th)}$ vs. T_J

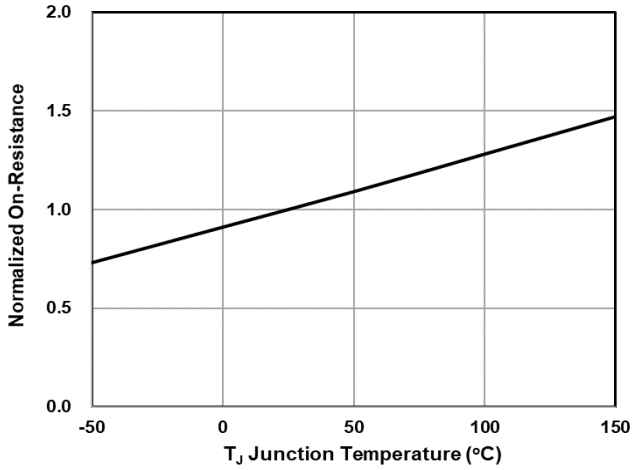

FIG.4-Normalized R_{DSON} vs. T_J

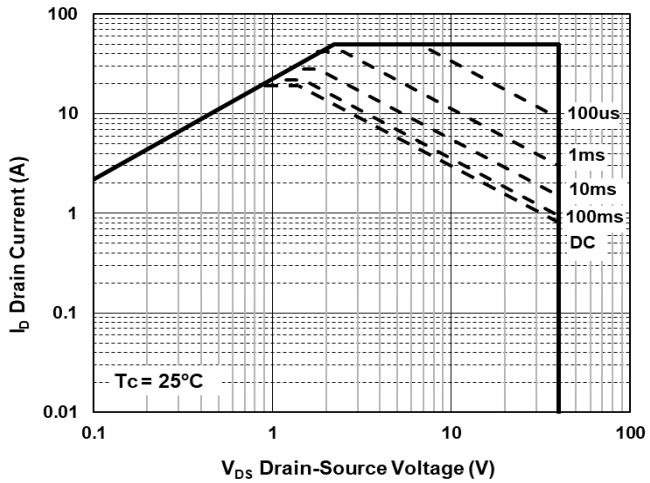

FIG.5-Safe Operating Area

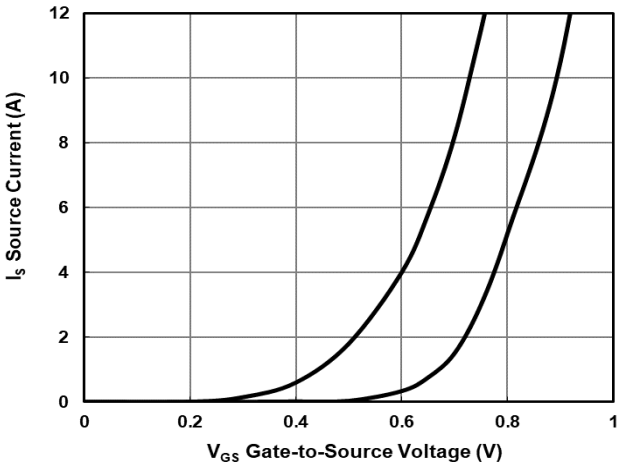

FIG.6-Source Drain Forward Characteristics

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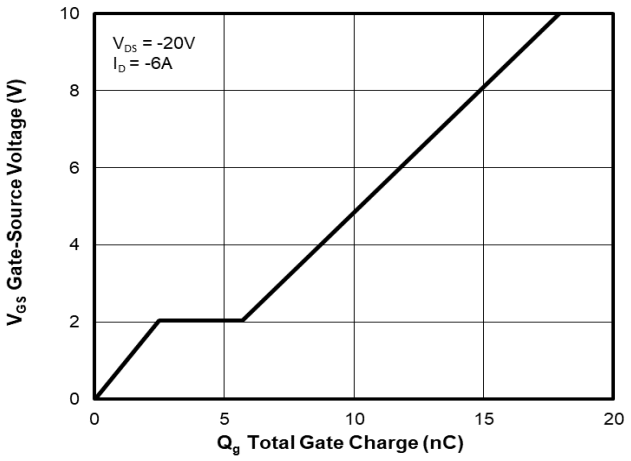

FIG.7-Gate Charge Characteristics

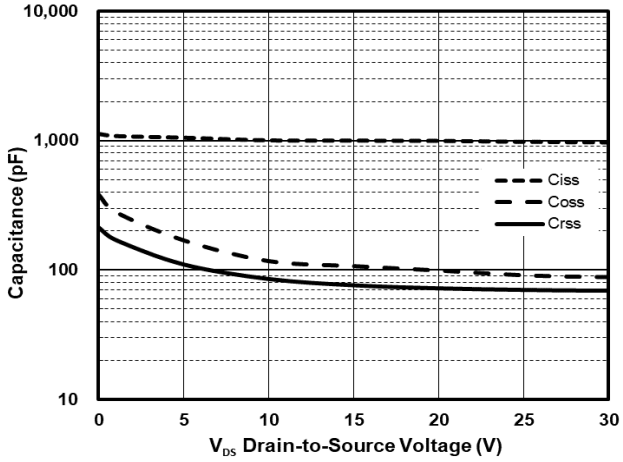

FIG.8-Capacitance Characteristics

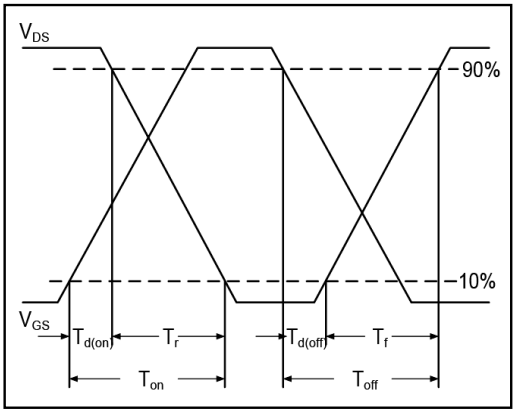

FIG.9-Switching Time Waveform

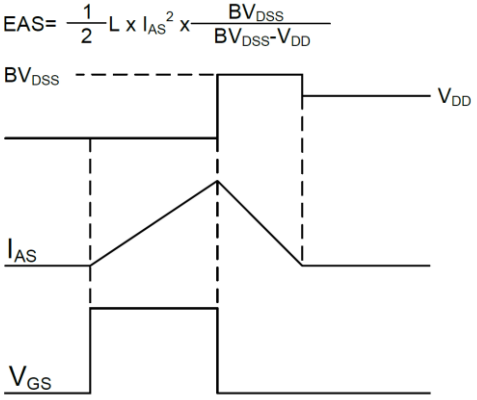

FIG.10-Unclamped Inductive Switching Waveform

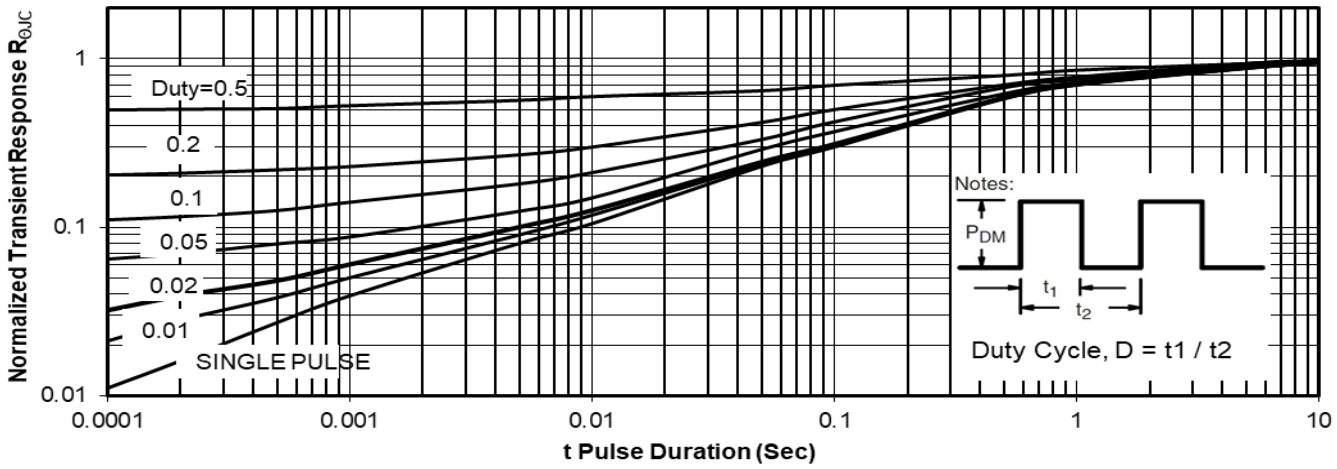

FIG.11-Normalized Maximum Transient Thermal Impedance

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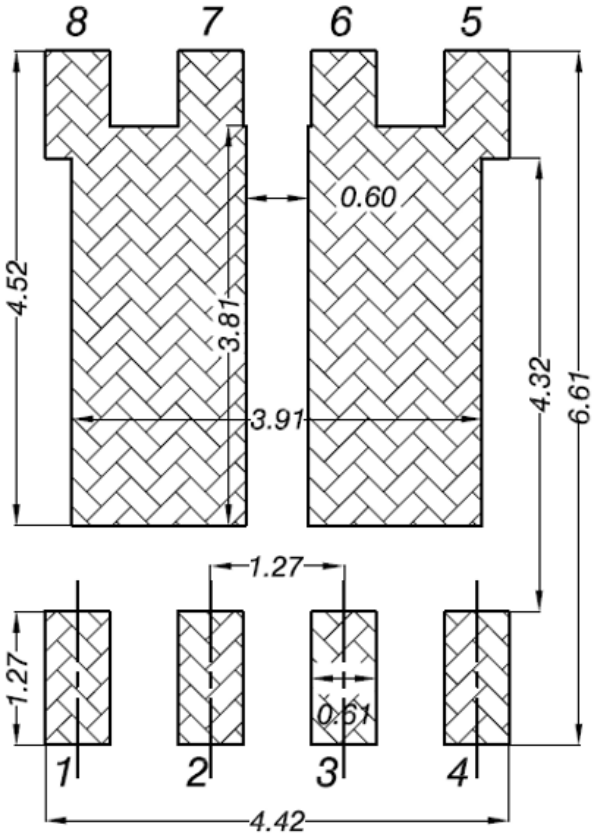
- **Land Pattern (For Reference Only)**



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